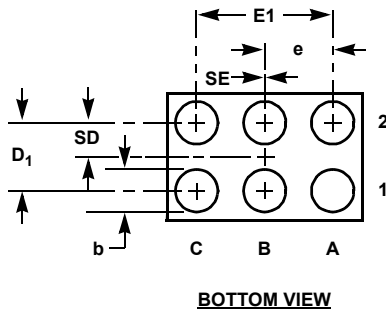
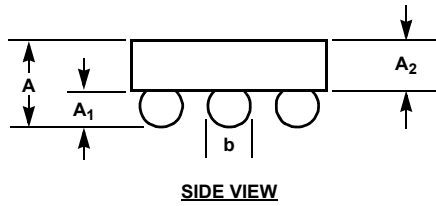
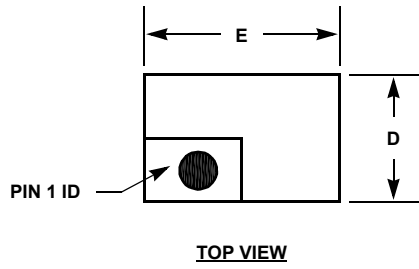


Plastic Packages for Integrated Circuits

Wafer Level Chip Scale Package (WLCSP)



W3x2.6C

3x2 ARRAY 6 BALL WAFER LEVEL CHIP SCALE PACKAGE

SYMBOL	MILLIMETERS
A	0.51 Min, 0.55 Max
A ₁	0.225 ±0.015
A ₂	0.305 ±0.013
b	Φ0.323 ±0.025
D	0.955 ±0.020
D ₁	0.50 BASIC
E	1.455 ±0.020
E ₁	1.00 BASIC
e	0.50 BASIC
SD	0.25 BASIC
SE	0.00 BASIC

Rev. 3 03/08

NOTES:

1. All dimensions are in millimeters.